

Description

The TD354 series combine two AlGaAs infrared emitting diode as the AC input which is optically coupled to a silicon planar phototransistor detector in a plastic SOP4 package.

With the robust coplanar double mold structure, TD354 series provide the most stable isolation feature.

Features

- High isolation 3750 VRMS
- CTR flexibility available see order information
- AC input with transistor output
- Operating temperature range 55 °C to 110 °C
- REACH compliance
- Halogen free
- MSL class 1
- Regulatory Approvals
 - UL UL1577
 - VDE EN60747-5-5(VDE0884-5)
 - CQC GB4943.1, GB8898

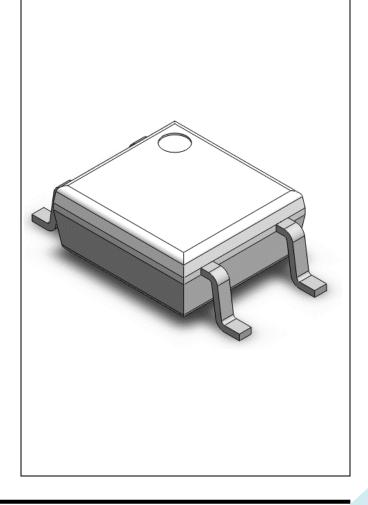
Applications

- AC line monitor
- Programmable controller
- Telephone line interface
- System appliance
- Measurement instrument

SCHEMATIC 1 2 PIN DEFINITION

- 1. Anode/Cathode
- 2. Cathode/Anode
 - 3. Emitter
 - 4. Collector

PACKAGE OUTLINE





ABSOLUTE MAXIMUM RATINGS							
PARAMETER	SYMBOL	VALUE	UNIT	NOTE			
INPUT							
Forward Current	lF	±60	mA				
Peak Forward Current	lfP	±1	А	1			
Input Power Dissipation	Pı	100	mW				
OU ⁻	OUTPUT						
Collector - Emitter Voltage	Vceo	80	V				
Emitter - Collector Voltage	VECO	7	V				
Collector Current	lc	50	mA				
Output Power Dissipation	Po	150	mW				
COMMON							
Total Power Dissipation	Ptot	200	mW				
Isolation Voltage	Viso	3750	Vrms	2			
Operating Temperature	Topr	-55~110	°C				
Storage Temperature	Tstg	-55~125	°C				
Soldering Temperature	Tsol	260	°C				

Note 1. 100µs pulse, 100Hz frequency

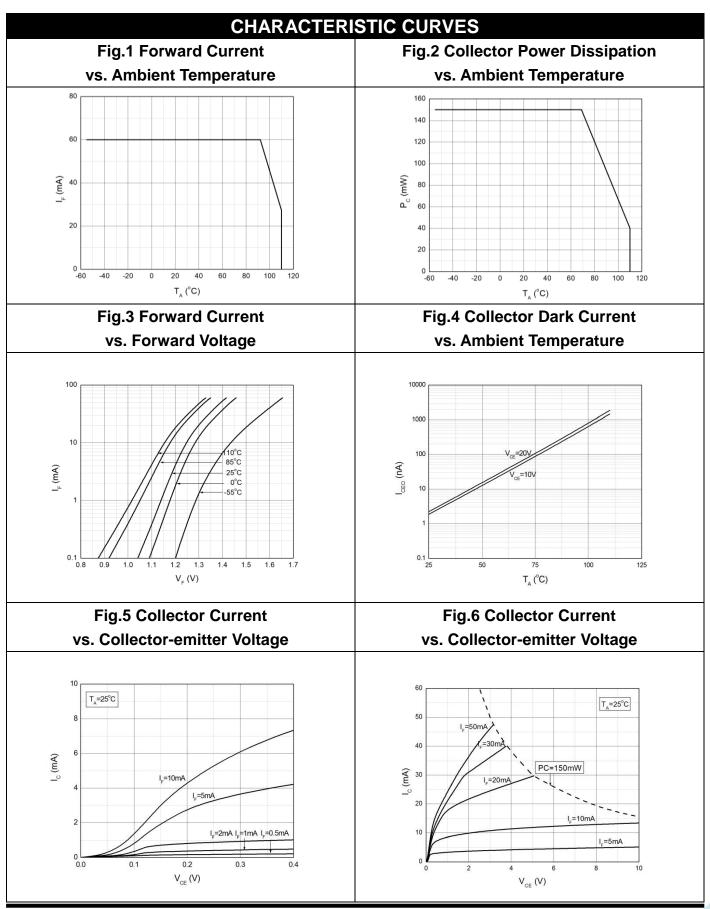
Note 2. AC For 1 Minute, R.H. = $40 \sim 60\%$



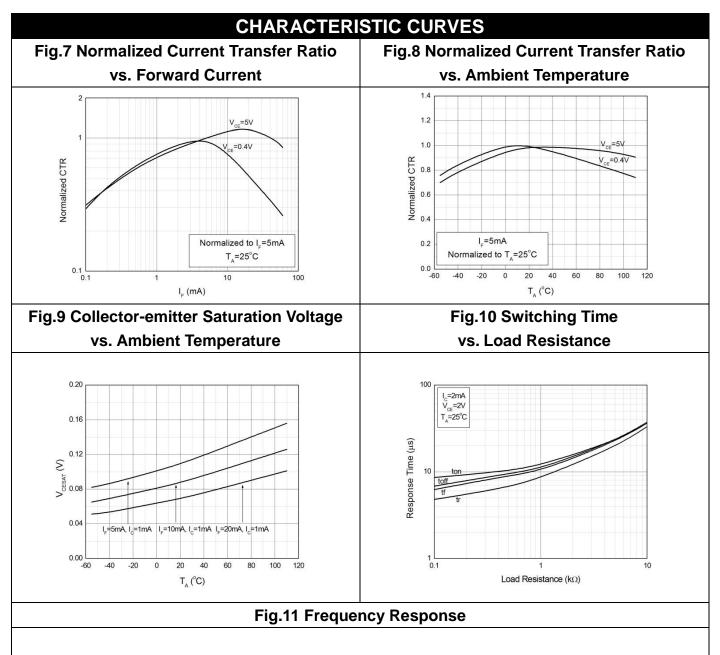
ELECTRICAL OPTICAL CHARACTERISTICS at Ta=25°C								
PARAMI	ETER	SYMBOL	MIN	TYP.	MAX.	UNIT	TEST CONDITION	NOTE
	INPUT							
Forward \	/oltage	VF	-	1.24	1.4	V	IF=±10mA	
Input Capa	acitance	Cin	-	10	-	pF	V=0, f=1kHz	
				OUT	PUT			
Collector Da	rk Current	ICEO	-	-	100	nA	VCE=20V, IF=0	
Collector- Breakdown		BVceo	80	-	-	V	IC=0.1mA, IF=0	
Emitter-Co Breakdown		BV _{ECO}	7	-	-	V	IE=0.1mA, IF=0	
		TR	ANSFE	R CHA	RACT	ERIS	TICS	
Current	TD354		20	-	300			
Transfer	TD354A	CTR	50	-	150	%	IF=±1mA, VCE=5V	
Ratio	TD354B		80	-	400			
CTR Symmetry		0.7	1	1.3		IF=±1mA, VCE=5V		
Collector- Saturation		VCE(sat)	-	0.07	0.2	V	IF=±20mA, IC=1mA	
Isolation Resistance		Riso	10^12	10^14	-	Ω	DC500V, 40 ~ 60% R.H.	
Floating Capacitance		Сю	-	0.4	1	pF	V=0, f=1MHz	
Response Ti	Response Time (Rise)		-	5	18	μs	VCE=2V, IC=2mA	3
Response Time (Fall)		tf	-	6	18	μs	RL=100Ω	3

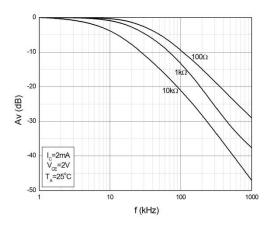
Note 3. Fig.12&13



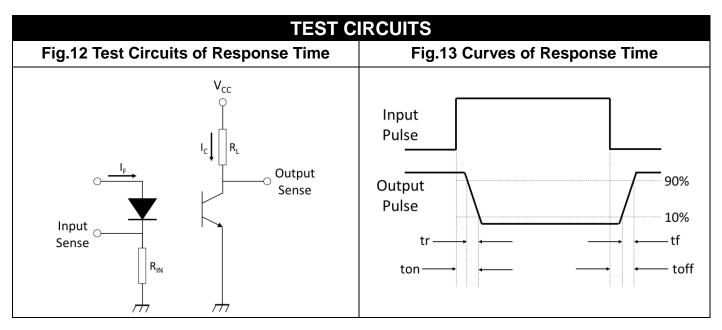




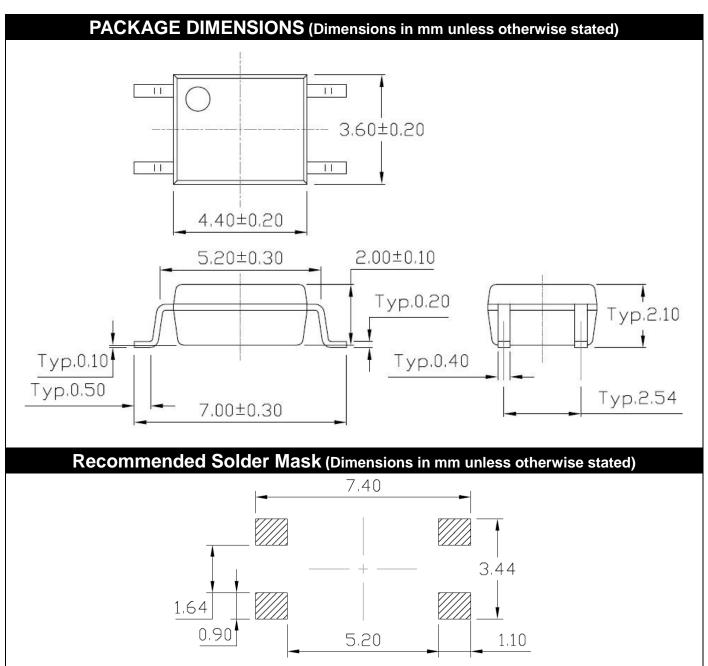








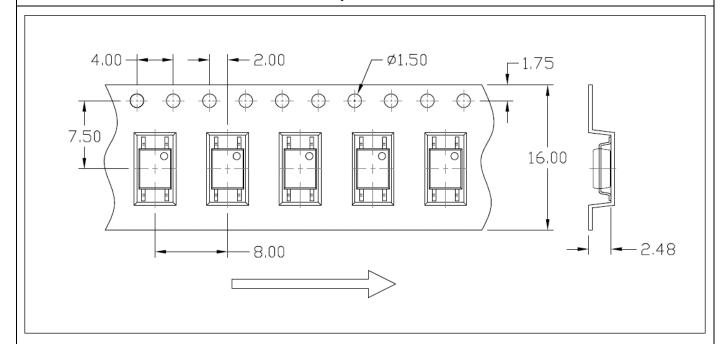




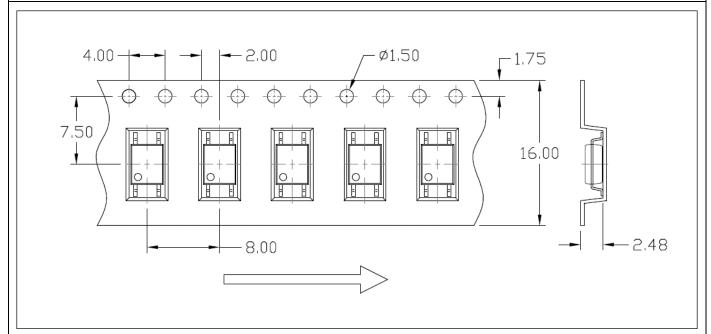


CARRIER TAPE SPECIFICATIONS (Dimensions in mm unless otherwise stated)

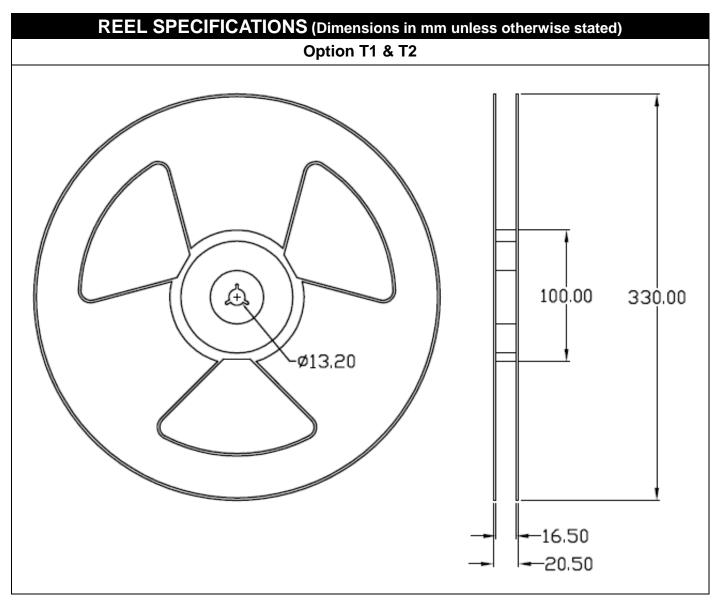
Option T1



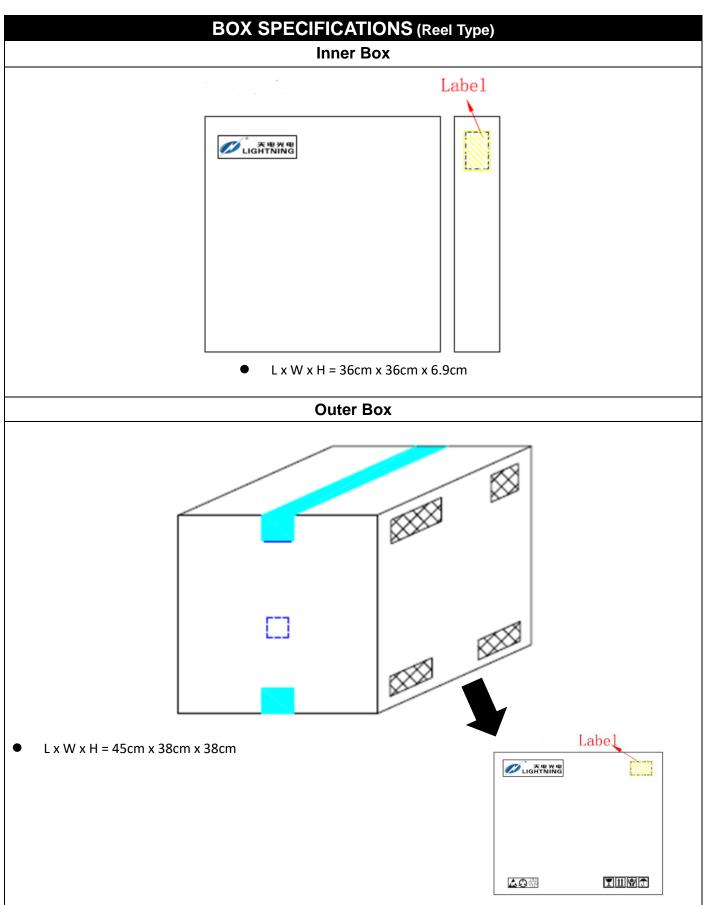
Option T2













ORDERING AND MARKING INFORMATION

MARKING INFORMATION



TD : Company Abbr.

354 : Part Number

X : CTR Rank

V : VDE Option

Υ : Fiscal Year

: Manufacturing Code Α

ww : Work Week

ORDERING INFORMATION

TD354X(Z)-GV

TD - Company Abbr.

354 - Part Number

X – Rank (A/B or None)

Z – Tape and Reel Option (T1/T2)

G - Green

V – VDE Option (V or None)

LABEL INFORMATION





Lot No: XXXXXXXXXX

Date Code: XXXX Q'ty: XXXX pcs

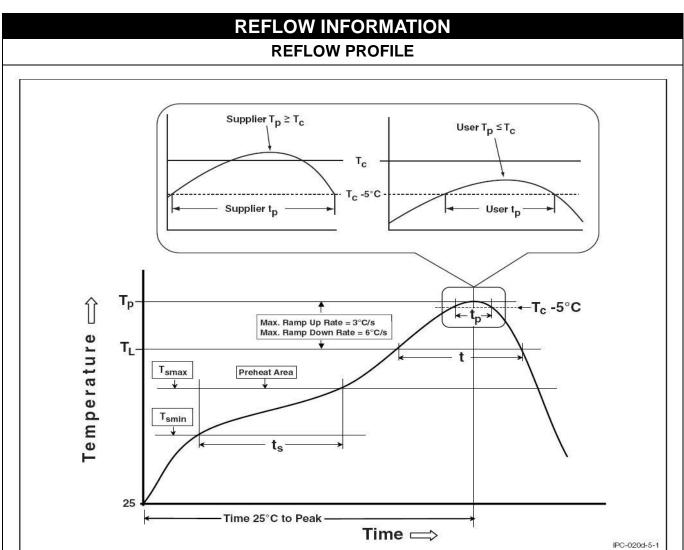




PACKING QUANTITY

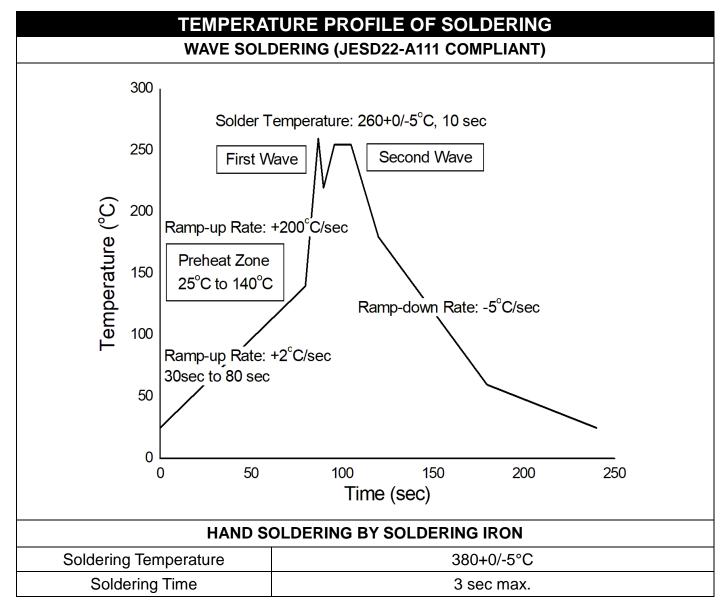
171011110 407111111				
Option	Quantity	Quantity - Inner box	Quantity – Outer box	
T1	3000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 45k Units	
T2	3000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 45k Units	





Profile Feature	Sn-Pb Assembly Profile	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	100	150°C
Temperature Max. (Tsmax)	150	200°C
Time (ts) from (Tsmin to Tsmax)	60-120 seconds	60-120 seconds
Ramp-up Rate (tL to tP)	3°C/second max.	3°C/second max.
Liquidous Temperature (TL)	183°C	217°C
Time (tL) Maintained Above (TL)	60 – 150 seconds	60 – 150 seconds
Peak Body Package Temperature	235°C +0°C / -5°C	260°C +0°C / -5°C
Time (tP) within 5°C of 260°C	20 seconds	30 seconds
Ramp-down Rate (TP to TL)	6°C/second max	6°C/second max
Time 25°C to Peak Temperature	6 minutes max.	8 minutes max.





- One time soldering is recommended for all soldering method.
- Do not solder more than three times for IR reflow soldering.



DISCLAIMER

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 reserves the right to make changes without further notices.
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- Please contact LIGHTNING sales agent for special application request.
- Immerge unit's body in solder paste is not recommended.
- Parameters provided in datasheets may vary in different applications and performance may vary
 over time. All operating parameters, including typical parameters, must be validated in each
 customer application by the customer's technical experts. Product specifications do not expand or
 otherwise modify LIGHTNING's terms and conditions of purchase, including but not limited to the
 warranty expressed therein.
- Discoloration might be occurred on the package surface after soldering, reflow or long-time use. It neither impacts the performance nor reliability.